
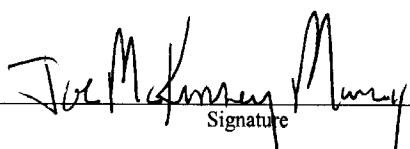
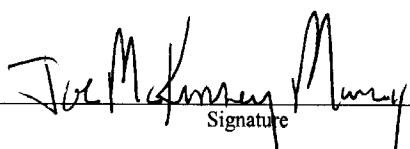
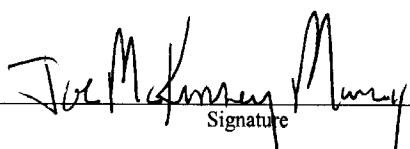


05-02-2005

Atty. Docket No.: 2450-0383P

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<b>R</b>  <b>HEET</b>				
<b>102895021</b> To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.				
1. Name of conveying party(ies): <b>SZ FONG ELECTRONICS CO., LTD.</b>  Additional name(s) of conveying party(ies) attached? <input type="checkbox"/> YES <input checked="" type="checkbox"/> NO	2. Name and address of receiving party(ies) Name: <b>JUNG FONG ELECTRONICS CO., LTD.</b> Internal Address: Street Address: <b>6F, No. 18, Lane 270, Sec. 3, Pei Shen Rd.</b> City: <b>SHEN KEN HSIANG, TAIPEI</b> State: <b>TAIWAN</b> ZIP: Country: <b>R.O.C.</b> Postal Code: Additional name(s) & address(es) attached? <input type="checkbox"/> YES <input checked="" type="checkbox"/> NO			
3. Nature of conveyance: <input checked="" type="checkbox"/> Assignment <input type="checkbox"/> Merger <input type="checkbox"/> Security Agreement <input type="checkbox"/> Change of Name <input type="checkbox"/> Other:	Execution Date: <b>March 28, 2005</b>			
4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is: A. Patent Application No(s). <b>10/419,911</b> B. Patent No.(s). <b>6,753,752</b> Additional numbers attached? <input type="checkbox"/> YES <input checked="" type="checkbox"/> NO				
5. Name and address of party to whom correspondence concerning document should be mailed: Name: <b>BIRCH, STEWART, KOLASCH &amp; BIRCH, LLP</b> Street Address: <b>P.O. BOX 747</b> City: <b>FALLS CHURCH</b> State: <b>VA</b> ZIP: <b>22040-0747</b> Country: <b>USA</b>	6. Total No. of applications/patents involved: <b>one (1)</b> 7. Total fee (37 C.F.R. § 3.41): <b>(\$160.00)</b> <input checked="" type="checkbox"/> Enclosed <input checked="" type="checkbox"/> Authorized to be charged to deposit account, if no fee attached. 8. Deposit account number: <b>02-2448</b> (Attach duplicate copy of this page if paying by deposit account)			
<b>DO NOT USE THIS SPACE</b>				
9. Statement and signature. <i>To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.</i>  <table style="width: 100%;"> <tr> <td style="width: 35%; text-align: center;"> <u>Joe McKinney Muncy, #32,334</u>            Name of Person Signing/Reg. No.         </td> <td style="width: 30%; text-align: center;">             Signature         </td> <td style="width: 35%; text-align: center;"> <u>May 2, 2005</u>            Date         </td> </tr> </table> Total number of pages including cover sheet, attachments, and document: <b>two (2)</b>		<u>Joe McKinney Muncy, #32,334</u> Name of Person Signing/Reg. No.	 Signature	<u>May 2, 2005</u> Date
<u>Joe McKinney Muncy, #32,334</u> Name of Person Signing/Reg. No.	 Signature	<u>May 2, 2005</u> Date		

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05/04/2005 DBYRNE 00000088 10419911

01 FC:8021	40.00 DP
02 FC:8023	120.00 DP

**PATENT**  
**REEL: 015972 FRAME: 0894**

## Patent Assignment

Whereas, **SZ Fong Electronics Co., Ltd.** having a business office at 6F, No. 260, Sec. 3, Pei Shen Rd., Shen Ken Hsiang, Taipei, Taiwan, R.O.C.

(hereinafter called the Assignor), is the proprietor of the following patent(s) and/or Patent Applications(s) in the United States of America under

Patent/ Patent Application No: **US 6,753,752 B1**

Title: **SILICON STEEL CORE SPACING STRUCTURE FOR IMPROVING INDUCTION**

Whereas, JUNG FONG ELECTRONICS CO., LTD. having a business office at 6F, No.18, Lane 270, Sec. 3, Pei Shen Rd., Shen ken Hsiang, Taipei, Taiwan, R.O.C.

(hereinafter called the Assignee), is desirous of acquiring the entire right, title, and interest of the Assignor in and to the aforesaid Patent(s) and or/Patent Application(s) and /or Patent(s) to be granted in respect thereof in the United States of America.

NOW, therefore, the Assignor, hereby sells, assigns and transfers with full title guarantee to the Assignee, its successors and assigns, absolutely all its right, title, and interest in and to the aforesaid Patent(s), Patent application(s) and Patents to be obtained therefor when granted including priority rights arising from the aforesaid patents(s) and/or application(s), and all emoluments, advantages, profits, and benefits accruing or belonging thereto in the United States of America for the full term or terms for which the same may be granted.

The assignor consents to the Assignee's proceeding with the aforesaid patent(s) and/or application(s), if any, in its own name in substitution of the said Assignor and the said Assignor agrees to do all that may be required to put the foregoing into effect.

The undersigned hereby grant(s) the law firm of ***Birch, Stewart, Kolasch & Birch, LLP*** the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

IN WITNESS WHEREOF this Assignment has been signed for and on behalf of the said Assignor

On Mar. 28, 2005

For and on behalf of SZ Fong Electronics Co., Ltd.

By LIN Kuo-Hua  
(Name) Kuo-Hua LIN (Title) **The president**

IN WITNESS WHEREOF this Assignment has been signed for and on behalf of the said Assignee

On Mar. 28, 2005

For and on behalf of JUNG FONG ELECTRONICS CO., LTD.

By JEN-YAO HU  
(Name) Jen-Yao HU (Title) **The president**